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December 2012

FAN156 Low Voltage Comparator

Features

- Low Supply Current: I_{DD} 6 μA (Typical)
- Single Power Supply Operation
- Wide Common-Mode Input Voltage Range
- Push-Pull Output Circuit
- Low Input Bias Current
- Internal Hysteresis
- Packaged in MicroPak™ 6

Applications

- Mobile Phones
- Alarm and Security Systems
- Personal Digital Assistants

Description

The FAN156 is a low-power single comparator that typically consumes less than 10 μ A of supply current. It is guaranteed to operate at a low voltage of 1.6 V and is fully operational up to 5.5 V, making it convenient for use in 1.8, 3.0 V, and 5.0 V systems.

The FAN156 has a complementary push-pull P- and N-channel output stage capable of driving a rail-to-rail output swing with a load ranging up to 5.0 mA.

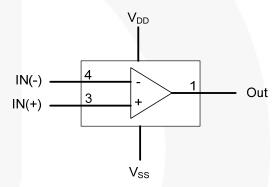


Figure 1. Functional Diagram

Ordering Information

Part Number	Top Mark	Operating Temperature Range	Package	Packing Method
FAN156L6X	CN	-40 to 85°C	6-Lead, MicroPak™, 1 x 1.45 mm Wide	5000 Units on Tape and Reel

Pin Configuration

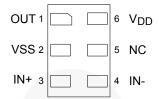


Figure 2. Pin Configuration (Top-Through View)

Pin Definitions

Pin#	Name	Description		
1	OUT	Comparator Output		
2	V _{SS}	Negative Supply Voltage		
3	IN+	Non-Inverting Input		
4	IN-	Inverting Input		
5	NC	No Connect		
6	V_{DD}	Positive Supply Voltage		

Function Table

Inputs	Outputs
IN(-) > IN(+)	Output LOW
IN(+) > IN(-)	Output HIGH

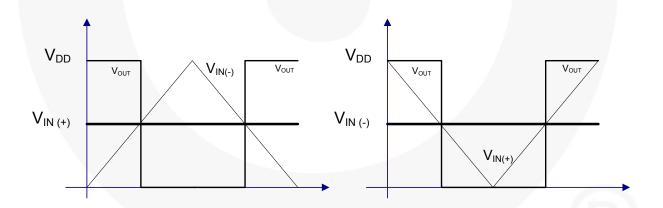


Figure 3. V_{IN} vs. V_{OUT}

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Condition	Min.	Max.	Unit
\/ to\/	Cumply Voltage		-3.0	+3.0	\/
V_{DD} to V_{SS}	Supply Voltage		0	6.0	V
DV _{IN}	Differential Input Voltage			±6	
V _{IN}	Input Voltage			V_{SS} to V_{DD}	V
ts	Output Short Circuit Duration ⁽¹⁾			Indefinite	S
TJ	Junction Temperature			+150	°C
T _{STG}	Storage Temperature Range		-65	+150	°C
P _D	Power Dissipation			194	mW
Θ_{JA}	Thermal Resistance			335	°C/W
	150 04000 4 0 0 mtors 50D	Air Gap		15	
	IEC 61000-4-2 System ESD	Contact		8	
	IEDEC IECDO A444 Human Badir	All Pins		8	
ESD	JEDEC JESD22-A114, Human Body Model	Pin to Pin: IN(-), IN(+) to V _{DD} or VSS		12	kV
	JEDEC JESD22-C101, Charged Device Model	All Pins		2	

Note:

1. The maximum total power dissipation must not be exceeded.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Condition	Min.	Max.	Unit
V to V	Dower Supply			+2.75	V
V _{DD} to V _{SS} Power Supply		0	5.50	V	
V_{DD}	Power Supply	V _{SS} 0 V	1.6	5.5	V
V _{IN}	Input Voltage			V_{SS} to V_{DD}	V
		V _{DD} 5.0 V		5	
I _{OH} /I _{OL}	I _{OH} /I _{OL} Output Sink/Source Current	V _{DD} 3.0 V		3	mA
		V _{DD} 1.6 V		1	
T _A	Operating Temperature, Free Air		-40	+85	°C

Electrical Characteristics

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
V _{DD} =5.5V, V _S	_{SS} =GND, and T _A =+25°C					
V _{HYS}	Input Hysteresis	V _{CM} =0.5 V _{DD}		4		mV
V _{IO}	Input Offset Voltage ⁽²⁾	V _{CM} =0.5 V _{DD}	-15	±1	+15	mV
I _{IO}	Input Offset Current			10		pA
l _l	Input Bias Current			10		pА
V_{CM}	Common Mode Input Voltage		V_{SS}		V_{DD}	V
CMRR	Common Mode Rejection Ratio ⁽³⁾	V _{CM} =V _{DD}		68		dB
I _{DD}	Supply Current			6	17	μA
PSRR	Power Supply Rejection Ratio ⁽³⁾	ΔV _{DD} =0.5 V	45	80		dB
		$V_O = V_{DD}$		60		
los	Output Short Circuit Current	V _O =V _{SS}		90		mA
V _{OL}	Low-Level Output Voltage	I _{SINK} =5.0 mA		0.1	0.3	V
V _{OH}	High-Level Output Voltage	I _{SOURCE} =5.0 mA	5.2	5.4		V
t _{PLH}	Propagation Delay (Turn-On)	Overdrive 20 mV, C _L =15 pF		0.40		μs
t _{PHL}	Propagation Delay (Turn-Off)	Overdrive=20 mV, C _L =15 pF		0.42		μs
t _{TLH}		C _L =50 pF		4.0		
t _{THL}	Response Time, Output Rise/Fall ⁽⁴⁾			5.4		ns
/ _{DD} =3V, V _{SS} =	=GND, and T _A =+25°C		1		•	
V _{HYS}	Input Hysteresis	V_{CM} =0.5 V_{DD}		4		mV
V _{IO}	Input Offset Voltage ⁽²⁾	V _{CM} =0.5 V _{DD}	-15	±1	+15	mV
I _{IO}	Input Offset Current			10		pА
II	Input Bias Current			10		pА
V_{CM}	Common Mode Input Voltage		V _{SS}		V_{DD}	V
CMRR	Common Mode Rejection Ratio ⁽³⁾	$V_{CM}=V_{DD}$		60		dB
I _{DD}	Supply Current			5.5	15.0	μA
PSRR	Power Supply Rejection Ratio ⁽³⁾	ΔV _{DD} =0.5 V	45	80		dB
		V _O =V _{DD}		27		
los	Output Short Circuit Current	V _O =V _{SS}		35		- mA
V _{OL}	Low-Level Output Voltage	I _{SINK} =3.0 mA		0.15	0.35	V
V _{OH}	High-Level Output Voltage	I _{SOURCE} =3.0 mA	2.65	2.85		V
t _{PLH}	Propagation Delay (Turn-On)	Overdrive=20 mV, C _L =15 pF		0.45		μs
t _{PHL}	Propagation Delay (Turn-Off)	Overdrive=20 mV, C _L =15 pF		0.47		μs
t _{TLH}	Response Time, Output Rise/Fall ⁽⁴⁾	C _L =50pF		6.1		ns
t_{THL}	Tooponso Time, output Nison all	OL OOP!		6.2		113

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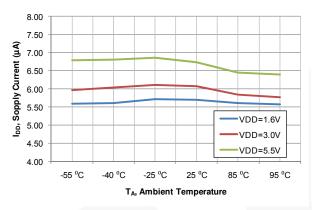
Electrical Characteristics (Continued)

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit	
V _{DD} 1.6V, V _S	S GND, and T _A =+25°C	•	•				
V _{HYS}	Input Hysteresis	V _{CM} =0.5 V _{DD}		3.5		mV	
V _{IO}	Input Offset Voltage ⁽²⁾	V _{CM} =0.5 V _{DD}	-15	±1	+15	mV	
I _{IO}	Input Offset Current			10		pА	
l _l	Input Bias Current			10		pА	
V_{CM}	Common Mode Input Voltage		V _{SS}		V_{DD}	V	
CMRR	Common Mode Rejection Ratio ⁽³⁾	V _{CM} =V _{DD}		56		dB	
I _{DD}	Supply Current			5	15	μA	
PSRR	Power Supply Rejection Ratio ⁽³⁾	ΔV _{DD} =0.5 V	45	80		dB	
1	Output Short Circuit Current	V _O =V _{DD}		5.5		A	
los	Output Short Circuit Current	V _O =V _{SS}		7.5		mA	
V _{OL}	Low-Level Output Voltage	I _{SINK} =1.0 mA		0.10	0.25	V	
V_{OH}	High-Level Output Voltage	I _{SOURCE} =1.0 mA	1.35	1.50		V	
t _{PLH}	Propagation Delay (Turn-On)	Overdrive=20 Mv, C _L =15pF		0.52		μs	
t _{PHL}	Propagation Delay (Turn-Off)	Overdrive=20 Mv, C _L =15 pF		0.54		μs	
t _{TLH}	Despense Time Output Dies /F-II(4)	C =50 pF		16.5		200	
t _{THL}	Response Time, Output Rise/Fall ⁽⁴⁾	C _L =50 pF		13.0		ns	

Notes:

- Differential input switching level is guaranteed at the minimum or maximum offset voltage, minus or plus half the maximum hysteresis voltage.
 Guaranteed by design and characterization data.
 Input signal: 1 kHz, square-wave signal with 10 ns edge rate.

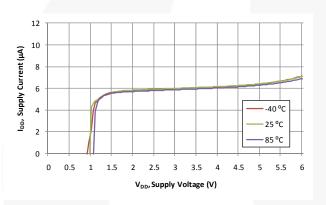
Typical Performance Characteristics



900 800 1.6 VDD 700 600 3.0 VDD Ŧ 5.5 VDD 500 ္ပ 400 300 200 100 0 0.01 0.1 10 100 1000 Temp. =25C Frequency (Khz) C_L = 15pF

Figure 4. Supply Current vs. Temperature

Figure 5. Supply Current vs. Output Transition Frequency



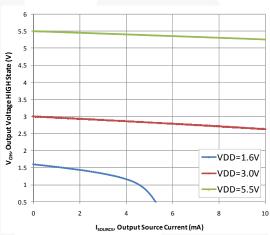
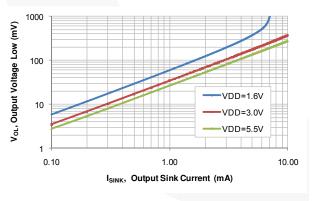


Figure 6. Supply Current vs. Supply Voltage

Figure 7. Output HIGH vs. Output Drive Current



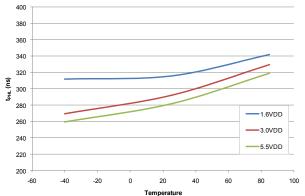
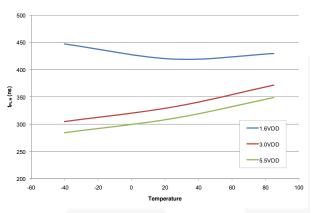


Figure 8. Output LOW vs. Output Drive Current

Figure 9. Propagation Delay (t_{PHL}) vs. Temperature

Typical Performance Characteristics (Continued)



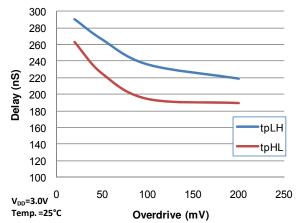


Figure 10. Propagation Delay (t_{PLH}) vs. Temperature

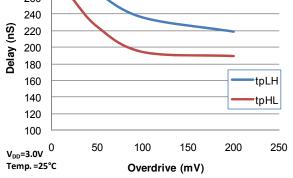
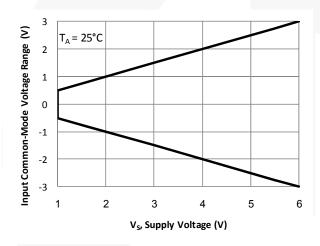


Figure 11. Propagation Delay vs. Input Overdrive



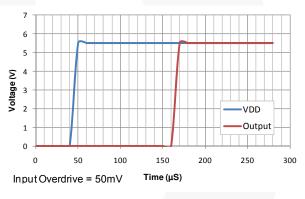
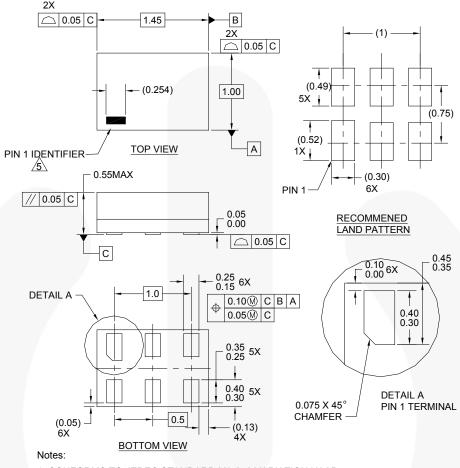


Figure 12. Input Common-Mode Voltage Range vs. **Supply Voltage**

Figure 13. Power-Up Delay

Physical Dimensions



- 1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994
- 4. FILENAME AND REVISION: MAC06AREV4
- 5. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY

OTHER LINE IN THE MARK CODE LAYOUT.

Figure 14. 6-Lead, MicroPak™, 1 x 1.45 mm Wide

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Package Designator	Package Designator Tape Section		Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
L6X	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed





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